

Silicon Fast Recovery Diode

$V_{RRM} = 100 \text{ V - } 1000 \text{ V}$
 $I_F = 40 \text{ A}$

Features

- High Surge Capability
- Types up to 1000 V V_{RRM}

DO-5 Package



Maximum ratings, at $T_j = 25^\circ\text{C}$, unless otherwise specified ("R" devices have leads reversed)

Parameter	Symbol	Conditions	FR40B(R)05	FR40D(R)05	FR40G(R)05	FR40J(R)05	Unit
Repetitive peak reverse voltage	V_{RRM}		100	200	400	600	V
RMS reverse voltage	V_{RMS}		70	140	280	420	V
DC blocking voltage	V_{DC}		100	200	400	600	V
Continuous forward current	I_F	$T_C \leq 100^\circ\text{C}$	40	40	40	40	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 8.3 \text{ ms}$	500	500	500	500	A
Operating temperature	T_j		-40 to 125	-40 to 125	-40 to 125	-40 to 125	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to 150	-40 to 150	-40 to 150	-40 to 150	$^\circ\text{C}$

Electrical characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	FR40B(R)05	FR40D(R)05	FR40G(R)05	FR40J(R)05	Unit
Diode forward voltage	V_F	$I_F = 40 \text{ A}, T_j = 25^\circ\text{C}$	1.4	1.4	1.4	1.4	V
Reverse current	I_R	$V_R = 100 \text{ V}, T_j = 25^\circ\text{C}$ $V_R = 100 \text{ V}, T_j = 125^\circ\text{C}$	25	25	25	25	μA
Recovery Time							
Maximum reverse recovery time	T_{RR}	$I_F=0.5 \text{ A}, I_R=1.0 \text{ A},$ $I_{RR}=0.25 \text{ A}$	500	500	500	500	nS
Thermal characteristics							
Thermal resistance, junction - case	R_{thJC}		0.8	0.8	0.8	0.8	$^\circ\text{C}/\text{W}$

